

CC112x Evaluation Module Kit Quick Start Guide

Opening the Box and Running the Packet Error Rate Test

1. Kit Contents



2 x CC1120 or CC1121 Evaluation Modules 2 x Antennas (type depending on frequency)

The 868-915 MHz RF boards in this kit are FCC and IC certified. The 169, 420-470 and 868-915 boards are tested to comply with ETSI/R&TTE over temperatures from 0 to $+35^{\circ}$ C.

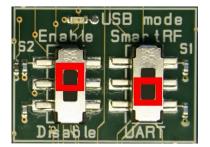
FCC/IC Regulatory Compliance (868-915 only) FCC Part 15 Class A Compliant IC ICES-003 Class A Compliant

Antenna types:

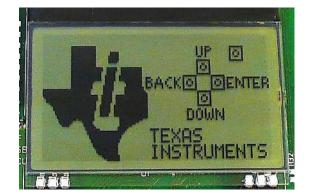
955 & 868-915 MHz: Pulse W5017, 2 dBi 420-470 MHz: Pulse SPWH24433TI, 0 dBi 169 MHz: Pulse SPHL24169TI

4. Select Board Mode

Use the switches S1 and S2 to select the operating mode of the board. For the sake of this quick start guide, please select "Enable" and "UART". This configuration will make it possible to communicate directly with the MSP430 over a virtual COM port on the PC.



7. Welcome Screen



2. How to use the Modules

The EMK is an add-on kit to supplement the CC1120DK with evaluation boards supporting additional frequency bands. This document covers the CC1120EMK and CC1121EMK.

The CC112xEM boards can be plugged into several development boards from Texas Instruments. Most notably, you can use the SmartRF Transceiver EB, which is included in the CC1120DK. This board lets you run a packet error rate (PER) test, control the device from SmartRF™ Studio and it can be used as a development platform.

It is also possible to connect the EM to other TI development boards with the appropriate connectors or to the basic "SoC Battery Board". The latter can be used as a carrier board for the EM to simplify the connection to other boards with a microcontroller. See:

http://www.ti.com/tool/soc-bb

This guide will show how to use the modules together with SmartRF Transceiver EB (TrxEB).

3. Plug the EM into the TrxEB



Insert a CC112xEM board into the TrxEB as shown above. Connect the antenna to the SMA connector on the EM.



Caution! The kit contains ESD sensitive components. Handle with care to prevent permanent damage.

5. Power Options

There are several ways of applying power to the TrxEB.

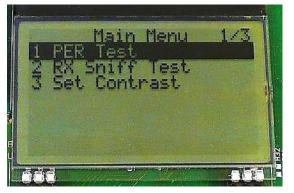
- 2 x 1.5V AA Non-Rechargeable Alkaline Batteries
- USB (5V through USB plug)
- External Power Supply (requirements below)
- MSP430 Debugger

When the power source is batteries or USB, the voltage regulators on the TrxEB will set the onboard supply voltage to 3.3VDC.

External Power Supply^I Requirements: Nom Voltage: 3.3VDC Max Current: 800 mA Efficiency Level V

Warning! To minimize risk of personal injury or property damage, never use rechargeable batteries to power the board.

8. Packet Error Rate Test



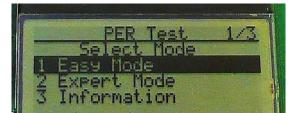
6. Select Power Source



Depending on the power source, make sure you connect jumpers to the appropriate pins on the "Power Source" header. For instance, if you use batteries, use a jumper to short-circuit pin 1 and 2 on the header. The last jumper in the row (pin 9-10) should always be mounted, unless the MSP430 FET is used as the power source.

Note that there should only be one active power source at any one time. Do not leave the board powered when unattended.

9. Select Test Mode



Turn on power with the Main Power switch. You should now see the Texas Instruments logo and a short description of the buttons on the LCD. Pushing any of the five buttons on the board will take you to the main menu.

NB! If you don't see anything on the screen make sure the mode switches are in the correct positions (see step 4 above).

Select the PER (Packet Error Rate) test by highlighting the selection using the up/down buttons. Confirm your selection by pressing Enter (right button).



The PER test can be run is several modes. Easy Mode sets up a one-way test and uses default settings. This test is convenient for practical range testing.

The other test modes are described in the "TrxEB RF PER Test Software Example User's Guide".

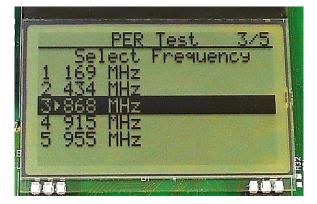
To proceed, highlight "Easy Mode" and press Enter (right button).



Web sites: www E2E Forum: www

www.ti.com/lprf www.ti.com/lprf-forum Make sure to subscribe to the Low-Power RF Newsletter to receive information about updates to documentation, new product releases, and more. Sign up on the TI web pages.

10. Select Frequency



Select which frequency to use for the test. Make sure that the evaluation modules you have match the selected frequency.

11. Select Mode

(transmitter) and the other as master (receiver). Select Slave on one board.





12. Establish Link

One of the boards must operate as the slave The slave node will now wait for a configuration package from the Master. The configuration contains the parameters used for the PER test.



The configuration package will be sent when you select "link devices" on the master node.



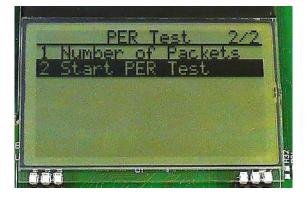
13. Link Established

When the initial linking has completed, the slave node will start the test by continuously transmitting packets to the master.



14. Start the Receiver (master)

of packets you want to receive in order to calculate the packet error.



When selecting "Start PER Test", the master (receiver) will begin to count the number of received packets and provide some statistics.

15. PER Test Results

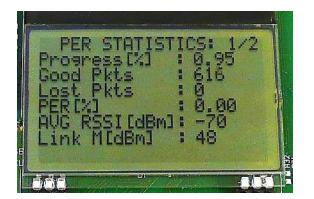
On the master node, you can select the number The master will display a window that plots the received signal strength (RSSI) for each packet.



Press the "Up" button to go to the detailed statistical window.

16. PER Test Results

The statistics window will show the error rate based on the number of lost or erroneous packets divided by the total number of packets that should have been received.



17. Troubleshooting

It you are experiencing problems with this test, please check the following:

- ٠ Nothing is shown in the display! Make sure the mode switches are in the correct positions (see step 4 above).
- Please visit the kit web page and check for updated SW and documentation. Updated SW can be downloaded to the device using IAR EW430 or SmartRF Flash Programmer.
- If you get poor PER results at short distances, try to move the transmitter and receiver further apart. The CC1120/CC1121 receiver may be saturated if it is too close to the other CC1120/CC1121 transmitting at full output power.

18. References

Please visit www.ti.com and

http://www.ti.com/tool/cc1120emk-169 http://www.ti.com/tool/cc1120emk-420-470 http://www.ti.com/tool/cc1120emk-868-915 http://www.ti.com/tool/cc1121emk-868-915 http://www.ti.com/tool/cc1120emk-955

On the kit product page, you will find additional documentation, links to other related kits and devices, updated software examples and software tools like SmartRF Studio.

You will also find a lot of information on the TI E2E forum at http://e2e.ti.com

We hope that you will enjoy working with the CC1120 and CC1121 devices.

SmartRF[™] Studio

1. Download and Install

Description/Fea	tures	Technic	al Documents	Suppo	rt & Community	
Order Now						
Part Number	Status	Price (USS)				
SMARTRFTH-STUDIO:	ACTIVE	free				
SmartRF Studie 21 Feb 2011 12, View all technic	DES views		4207 KB).			Smart - Studio 7
Description						
Smart8F ^{III} Studio is a Windows application that can be used to evaluate and configure Low Paeer RF-ICs from Texas Instruments. The application will help designers of RF systems to easily evaluate the RF-ICs at an early stage in the design process. It is appecially useful for measuration of motionarian evaluation for material taxing of the RF evaluates and for finding				to for	(12707-01)	

Before connecting SmartRF TrxEB to your PC, download and install SmartRF Studio from www.ti.com/smartrfstudio.

2. Launch SmartRF Studio

SmartR	F™ Stu	dio 7	1.4.16 Beta	_ 🗶 🚱
Sub 1 GHz ISM ban CC430 Sub-1GHz System-on-Chip B C	d (1 Connected) CC1100 Sub-1GHz Transceiver	CC1100E Sub-1GHz Transceiver	4 GHz CC1101 Sub-1GHz Transceiver	CC110L Sub-1GHz Transceiver
CC1110 Sub-1GHz System-on-Chip	CC1111 Sub-1GHz USB System-on-Chip	CC113L Sub-1GHz Receiver	CC1120 Sub-1GHz Transceiver	CC1121 Sub-1GHz Transceiver

3. Test the Radio

E Casy State	Expert Mode	22 Register View	RF Parameters	0005 - CC1120 - Register 1	lew.
Typical settings				Repater exp	not
Category	Setting name				-
▶ Generic 868MHz			1	Register	
▼ Generic 434MHz			E	 IDCFG3 	
			C narrow band, optimized	IOCEG2	
K		te Bik rate: 150kbps, 4-5P	K narrowband high thrs.	IDCFG1	
		 BE rate: 9.64bps, 4-GPS BE rate: 2006bps, 4-GF 		► IDCFG8	
	Freenandery, Fort. 9, 4241	12, DK (B)R. 2010039, 4101	an, nak unvegepte	SYNC3	1
				▶ SYNC2	
RF Parameters				Synct	2
Carrier frequency	Xtal frequency	Symbol rate	Dit rate	SYNCO	
434.000000 la MHz	32 000000 · MHz	75 8805	150 kbos	SYNC_CEG1	
EX Dec Bill	Wedulation format	Deviation	TX power	SYNC_CFG0	
				 DEVIATION_M MODEFG DEV E 	
200.000000 kHz	4-GESK +	B2.763672 8Hz	14 • dBm	MODERG_DEV_E DEFET_CFG	
Manchester enable	PA ramping			> PREAMBLE CFG1	
and Wratesbarn Lean	No. And Address of Control of Con			PREAMBLE CFG0	
				> TREQ # CEG	
Continuous TX Conten	ous RX Packet TX Pack	et RX RF Device Corretai	nda.	a loc	
Facket payload size:	30 Add set	turther		> CHAN BW	
				IN MEMORIAL	
Packet count:	100 Infinite		E 31	b MOMETGO	
Random 47 de b3	12 4d c8 43 bb 8b a6 11 03	Sa 7d 09 38 2	and the second	> DRATE2	
C Text			1 10	> DRATES	
C Hax			M (1)	> DRATED	
C: INK			×	h ACC DEF	

After installing the tool, connect the EB to the PC You can now configure the radio, run using the USB cable and start SmartRF Studio. Select the "Sub 1 GHz" tab and double click the highlighted CC1120 or CC1121 device icon.

performance tests, export register settings and run link tests with another CC1120 or C1121 on a SmartRF TrxEB connected to the PC.

When using an external power supply, make sure it meets the listed requirements in addition to complying with applicable regional product regulatory and safety certification requirements such as UL, CSA, VDE, CCC, and PSE.

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